

## N-Channel 22-V (D-S) 175°C MOSFET

| PRODUCT SUMMARY |                           |                        |
|-----------------|---------------------------|------------------------|
| $V_{DS}$ (V)    | $r_{DS(on)}$ ( $\Omega$ ) | $I_D$ (A) <sup>d</sup> |
| 24 <sup>c</sup> | 0.006 @ $V_{GS} = 10$ V   | 80                     |
|                 | 0.0095 @ $V_{GS} = 4.5$ V | 64                     |

### FEATURES

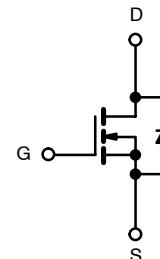
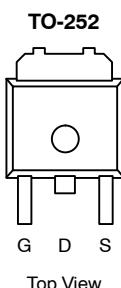
- TrenchFET® Power MOSFET
- 175°C Junction Temperature
- PWM Optimized for High Efficiency
- 100%  $R_g$  Tested
- Lead (Pb)-Free Version is RoHS Compliant



Pb-free Available

### APPLICATIONS

- Synchronous Buck DC/DC Conversion
  - Desktop
  - Server



N-Channel MOSFET

 Ordering Information: SUD50N024-06P  
 SUD50N024-06P-E3 (Lead (Pb)-Free)

| ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED) |                           |                        |                  |      |
|---|---------------------------|------------------------|------------------|------|
| Parameter   |                           | Symbol                 | Limit            | Unit |
| Drain-Source Pulse Voltage  |                           | $V_{DS(\text{pulse})}$ | 24 <sup>c</sup>  | V    |
| Drain-Source Voltage  |                           | $V_{DS}$               | 22               |      |
| Gate-Source Voltage   |                           | $V_{GS}$               | $\pm 20$         |      |
| Continuous Drain Current <sup>a</sup>                                       | $T_C = 25^\circ\text{C}$  | $I_D$                  | 80 <sup>d</sup>  | A    |
|   | $T_C = 100^\circ\text{C}$ |                        | 56 <sup>d</sup>  |      |
| Pulsed Drain Current  |                           | $I_{DM}$               | 100              |      |
| Continuous Source Current (Diode Conduction) <sup>a</sup>                   |                           | $I_S$                  | 26               |      |
| Avalanche Current, Single Pulse   | $L = 0.1 \text{ mH}$      | $I_{AS}$               | 45               |      |
| Avalanche Energy, Single Pulse  |                           | $E_{AS}$               | 101              | mJ   |
| Maximum Power Dissipation   | $T_A = 25^\circ\text{C}$  | $P_D$                  | 6.8 <sup>a</sup> | W    |
|   | $T_C = 25^\circ\text{C}$  |                        | 65               |      |
| Operating Junction and Storage Temperature Range                            |                           | $T_J, T_{stg}$         | -55 to 175       | °C   |

| THERMAL RESISTANCE RATINGS               |                         |            |         |         |      |
|--|-------------------------|------------|---------|---------|------|
| Parameter                                |                         | Symbol     | Typical | Maximum | Unit |
| Maximum Junction-to-Ambient <sup>a</sup> | $t \leq 10 \text{ sec}$ | $R_{thJA}$ | 18      | 22      | °C/W |
|  | Steady State            |            | 40      | 50      |      |
| Maximum Junction-to-Case                 |                         | $R_{thJC}$ | 1.9     | 2.3     |      |

## Notes

- Surface Mounted on FR4 Board,  $t \leq 10 \text{ sec}$ .
- Limited by package
- Pulse condition:  $T_A = 105^\circ\text{C}$ , 50 ns, 300 kHz operation
- Calculation based on maximum allowable Junction Temperature. Package limitation current is 50 A.

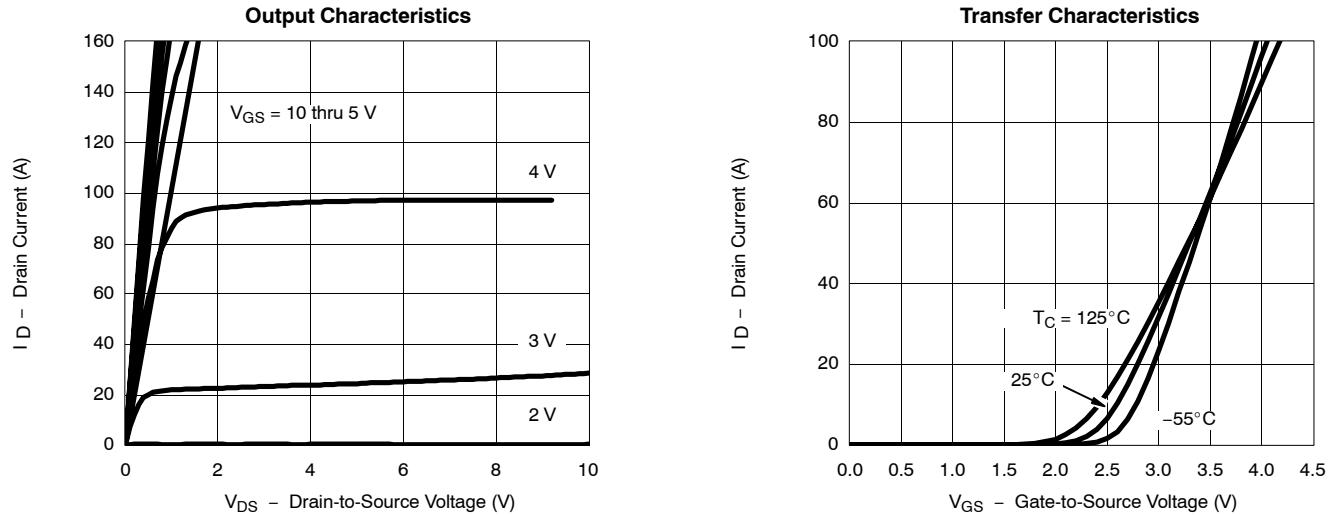
**SPECIFICATIONS ( $T_J = 25^\circ\text{C}$  UNLESS OTHERWISE NOTED)**

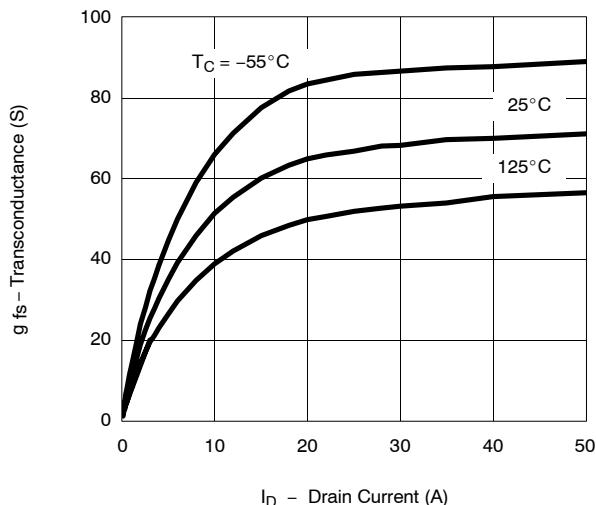
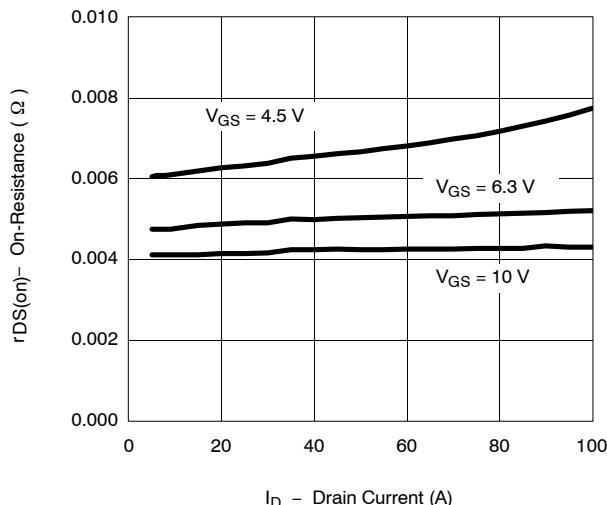
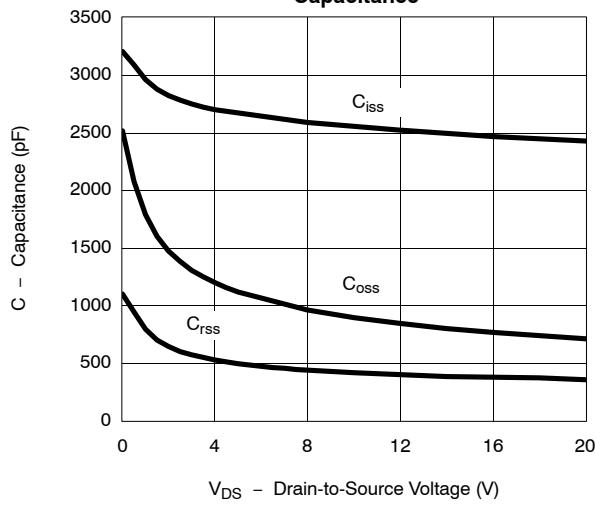
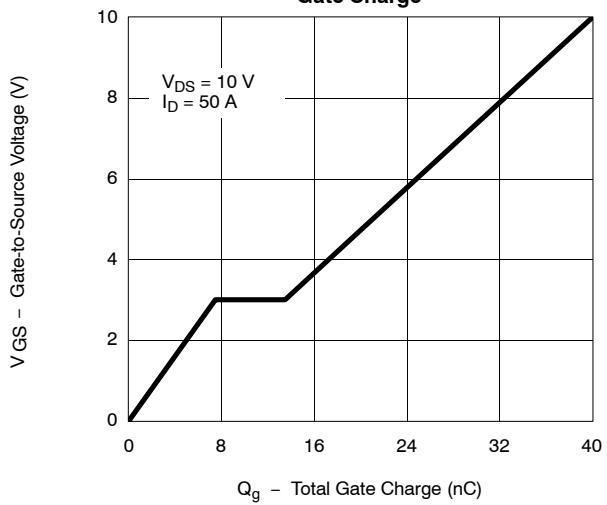
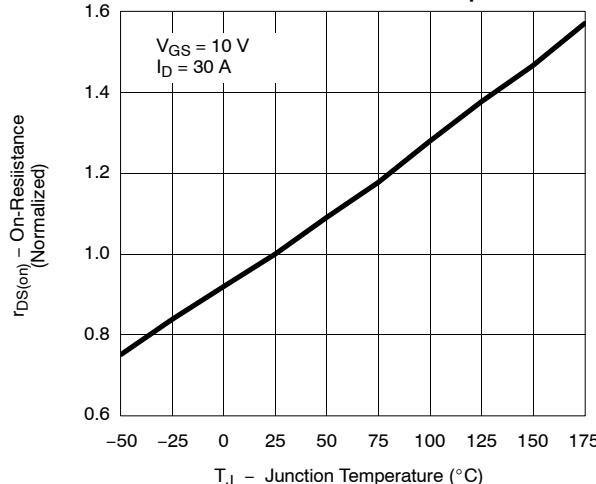
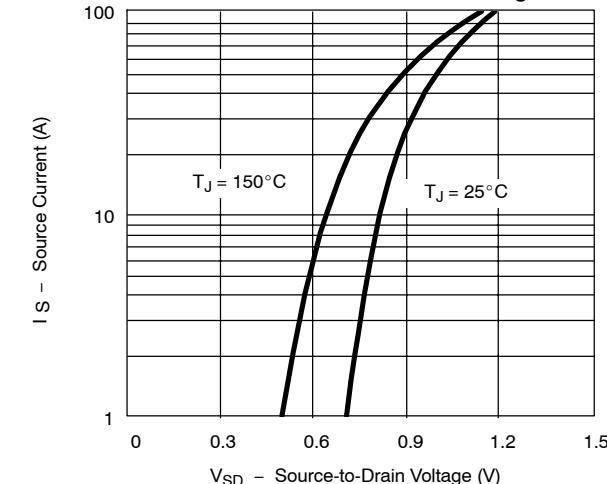
| Parameter  | Symbol                      | Test Condition   | Min | Typ <sup>a</sup> | Max       | Unit          |
|--|-----------------------------|--|-----|------------------|-----------|---------------|
| <b>Static</b>  |                             |  |     |                  |           |               |
| Drain-Source Breakdown Voltage   | $V_{(\text{BR})\text{DSS}}$ | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$                          | 22  |                  |           | V             |
| Gate Threshold Voltage   | $V_{GS(\text{th})}$         | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$                               | 0.8 |                  | 3.0       |               |
| Gate-Body Leakage  | $I_{GSS}$                   | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$                      |     |                  | $\pm 100$ | nA            |
| Zero Gate Voltage Drain Current  | $I_{DSS}$                   | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$                          |     | 1                |           | $\mu\text{A}$ |
|  |                             | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125^\circ\text{C}$ |     | 50               |           |               |
| On-State Drain Current <sup>b</sup>  | $I_{D(\text{on})}$          | $V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$                          | 50  |                  |           | A             |
| Drain-Source On-State Resistance <sup>b</sup>  | $r_{DS(\text{on})}$         | $V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$                            |     | 0.0046           | 0.006     |               |
|  |                             | $V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 125^\circ\text{C}$   |     |                  | 0.0084    |               |
|  |                             | $V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$                           |     | 0.0073           | 0.0095    | $\Omega$      |
| Forward Transconductance <sup>b</sup>  | $g_{fs}$                    | $V_{DS} = 15 \text{ V}, I_D = 20 \text{ A}$                            | 15  |                  |           | S             |
| <b>Dynamic<sup>a</sup></b>   |                             |  |     |                  |           |               |
| Input Capacitance  | $C_{iss}$                   | $V_{GS} = 0 \text{ V}, V_{DS} = 10 \text{ V}, f = 1 \text{ MHz}$       |     | 2550             |           |               |
| Output Capacitance   | $C_{oss}$                   |  |     | 900              |           | pF            |
| Reverse Transfer Capacitance   | $C_{rss}$                   |  |     | 415              |           |               |
| Gate Resistance  | $R_g$                       |  | 0.7 | 1.5              | 2.1       | $\Omega$      |
| Total Gate Charge <sup>c</sup>   | $Q_g$                       | $V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 50 \text{ A}$    |     | 19               | 30        |               |
| Gate-Source Charge <sup>c</sup>  | $Q_{gs}$                    |  |     | 7.5              |           | nC            |
| Gate-Drain Charge <sup>c</sup>   | $Q_{gd}$                    |  |     | 6.0              |           |               |
| Turn-On Delay Time <sup>c</sup>  | $t_{d(\text{on})}$          |  |     | 11               | 20        |               |
| Rise Time <sup>c</sup>   | $t_r$                       |  |     | 10               | 15        |               |
| Turn-Off Delay Time <sup>c</sup>   | $t_{d(\text{off})}$         |  |     | 24               | 35        | ns            |
| Fall Time <sup>c</sup>   | $t_f$                       |  |     | 9                | 15        |               |
| <b>Source-Drain Diode Ratings and Characteristic (<math>T_C = 25^\circ\text{C}</math>)</b> |                             |  |     |                  |           |               |
| Pulsed Current   | $I_{SM}$                    |  |     |                  | 100       | A             |
| Diode Forward Voltage <sup>b</sup>   | $V_{SD}$                    | $I_F = 50 \text{ A}, V_{GS} = 0 \text{ V}$                             |     | 1.2              | 1.5       | V             |
| Source-Drain Reverse Recovery Time   | $t_{rr}$                    | $I_F = 50 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$                |     | 35               | 70        | ns            |

## Notes

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .
- c. Independent of operating temperature.

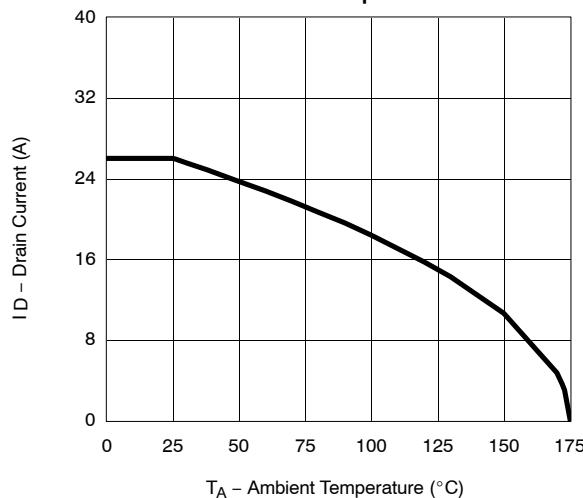
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS ( $25^\circ\text{C}$  UNLESS NOTED)**

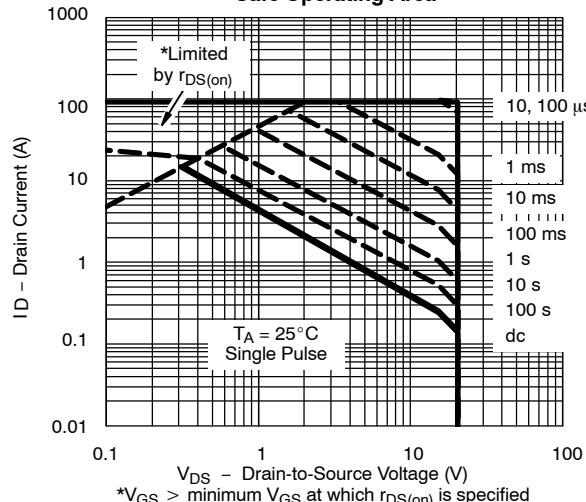
**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**
**Transconductance**

**On-Resistance vs. Drain Current**

**Capacitance**

**Gate Charge**

**On-Resistance vs. Junction Temperature**

**Source-Drain Diode Forward Voltage**


## THERMAL RATINGS

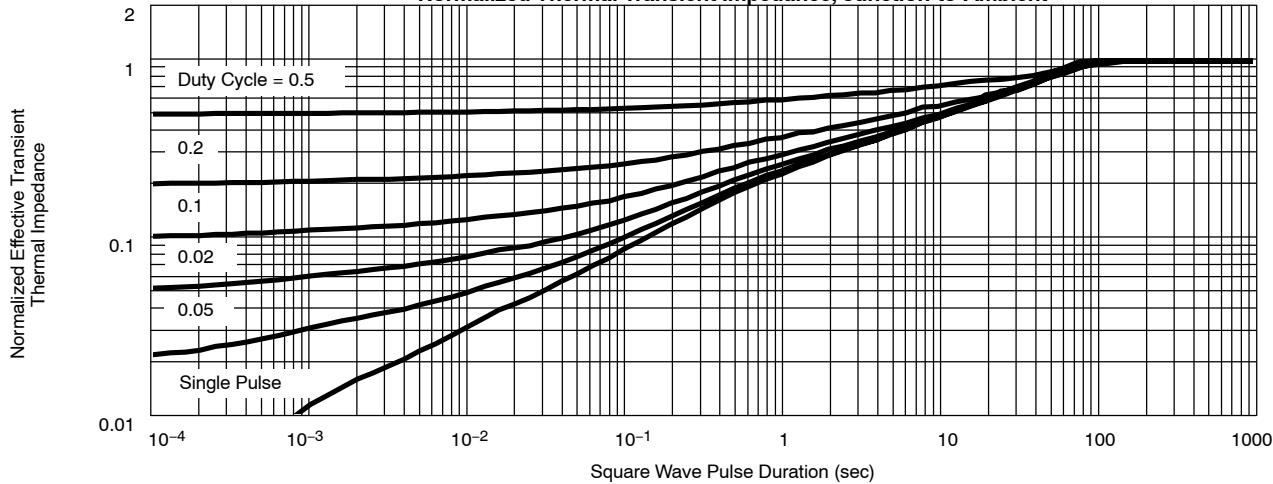
**Maximum Drain Current vs.  
Ambient Temperature**



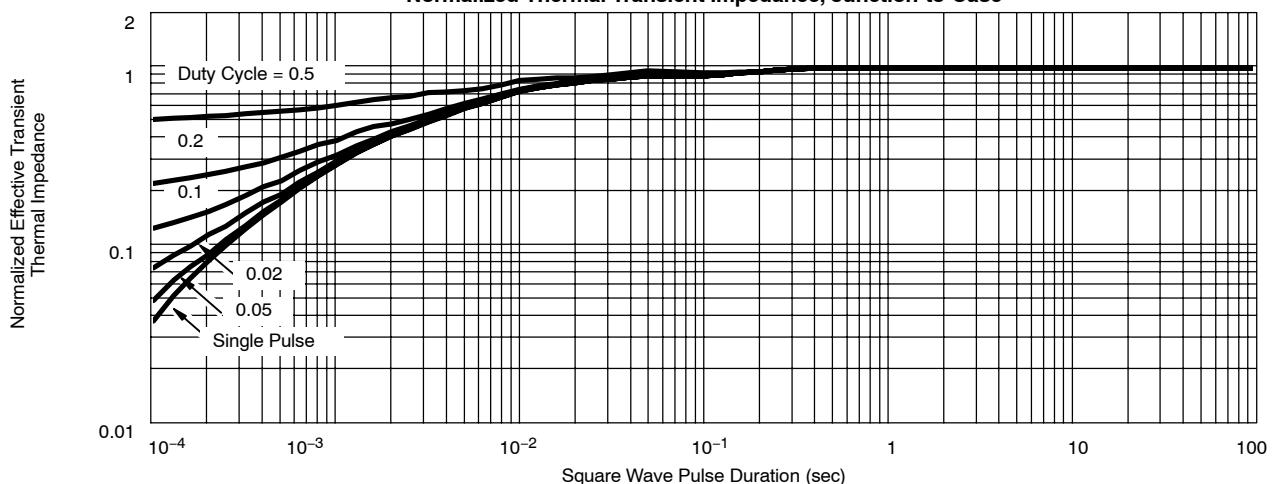
**Safe Operating Area**



**Normalized Thermal Transient Impedance, Junction-to-Ambient**



**Normalized Thermal Transient Impedance, Junction-to-Case**



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